

Docket: 3303-23

### DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

### **SURFACE MICROMACHINED MECHANICAL MICROPUMPS AND FLUID SHEAR MIXING, LYSING, AND SEPARATION MICROSYSTEMS**

the specification of which (check one)

- is attached hereto.  
 was filed on 10/30/03 as Application Serial No. 10/697,412 and  
was amended on \_\_\_\_\_ (if applicable).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations Section 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

#### Prior Foreign Application(s)

#### Priority Claimed

Yes No

(Number)	(Country)	(Day/Month/Year Filed)
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Yes No

(Number)	(Country)	(Day/Month/Year Filed)
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I hereby claim the benefit under Title 35, United States Code, §119(e) of any U.S. application listed below and identified as a provisional application, insofar as the subject matter of each of the claims of this application is not disclosed in the prior U.S. application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose information material to the patentability of this application as defined in Title 37,

Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

Prior U.S. Provisional Application(s)

(Appln. Serial No.) (Filing Date)

60/422,548 October 31, 2002

I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Section 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Appln. Serial No.) (Filing Date) (Status-patent, pending, abandoned)

(Appln. Serial No.) (Filing Date) (Status-patent, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

**POWER OF ATTORNEY:** As a named inventor, I hereby appoint the following attorneys and/or agents to prosecute this application and transact all business in the Patent and Trademark Office connected therewith:

J. Rodman Steele, Jr.	Reg. No. 25,931
Gregory A. Nelson	Reg. No. 30,577
Joseph W. Bain	Reg. No. 34,290
Stanley A. Kim	Reg. No. 42,730
Mark D. Passler	Reg. No. 40,784
Neil R. Jetter	Reg. No. 48,803
Pablo Meles	Reg. No. 33,739
Kevin T. Cuenot	Reg. No. 46,283
Terry Forsythe	Reg. No. 47,569
Amy A. Ostrom	Reg. No. 52,088
Mark M. Zylka	Reg. No. 48,518
Michael Dixon	Reg. No. 46,665
Theodore M. Green	Reg. No. 41,801
Brian Buchheit	Reg. No. 52,867
Peter A. Chiabotti	Reg. No. 54,603
Margaret J. McLaren	Reg. No. 53,303
Sarah Smith	Reg. No. 50,488

Send correspondence to Michael Dixon, Esq., Akerman, Senterfitt, 222 Lakeview Avenue, 4<sup>th</sup> Floor, P.O. Box 3188, West Palm Beach, Florida 33402-3188 and direct all telephone calls to Michael Dixon, Esq. at (561) 653-5000.

FULL NAME OF INVENTOR: CHING JEN CHEN

INVENTOR'S SIGNATURE: Ching Jen Chen DATE: 1-22-04

RESIDENCE: 4843 High Grove Drive, Tallahassee, Florida 32308

CITIZENSHIP: United States of America

FULL NAME OF INVENTOR: PAUL CHARLES GALAMBOS

INVENTOR'S SIGNATURE: \_\_\_\_\_ DATE: \_\_\_\_\_

RESIDENCE: 3506 Monte Vista Boulevard NE, Albuquerque, NM 87106

CITIZENSHIP: United States of America

FULL NAME OF INVENTOR: YOUSEF HAIK

INVENTOR'S SIGNATURE: ~~Yousef Haik~~

DATE: 1/21/04

RESIDENCE: 1817 Aaron Drive, Tallahassee, FL 32303

CITIZENSHIP: Jordanian

FULL NAME OF INVENTOR: MOHAMMAD IBRAHIM KILANI

INVENTOR'S SIGNATURE: Mohammad Kilani DATE: 11/17/2003

RESIDENCE: 10 Abdullah bin Massoud Street, Shmeisani, Amman, Jordan

CITIZENSHIP: Jordanian



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(Number)	(Country)	(Day/Month/Year Filed)	Yes No
			Yes No

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(Appn. Serial No.)	(Filing Date)
<u>60/422,548</u>	<u>October 31, 2002</u>

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Peter A. Chiabotti	Reg. No. 54,603
Margaret J. McLaren	Reg. No. 53,303
Sarah Smith	Reg. No. 50,488

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FULL NAME OF INVENTOR: CHING JEN CHEN

INVENTOR'S SIGNATURE: \_\_\_\_\_ DATE: \_\_\_\_\_

RESIDENCE: 4643 High Grove Drive, Tallahassee, Florida 32308

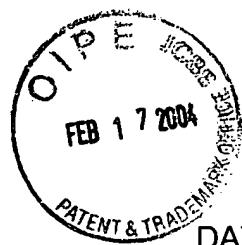
CITIZENSHIP: United States of America

FULL NAME OF INVENTOR: PAUL CHARLES GALAMBOS

INVENTOR'S SIGNATURE: Paul Charles Galambos DATE: 1/20/2004

RESIDENCE: 3506 Monte Vista Boulevard NE, Albuquerque, NM 87106

CITIZENSHIP: United States of America



FULL NAME OF INVENTOR: YOUSEF HAIK

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